DB201 THRU DB207

SINGLE-PHASE GLASS PASSIVATED SILICON BRIDGE RECTIFIER

REVERSE VOLTAGE: FORWARD CURRENT:

50 to 1000 VOLTS 2.0 AMPERE

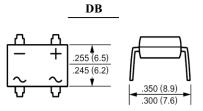


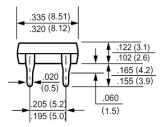
FEATURES

- \cdot Glass passivated chip junction
- \cdot Low forward voltage drop
- \cdot High surge overload rating of 50 Amperes peak
- · Ideal for printed circuit board
- \cdot High temperature soldering guaranteed:
- 260°C for 10 seconds

MECHANICAL DATA

Case: Molded plastic, DB Epoxy: UL 94V-O rate flame retardant Terminals: Leads solderable per MIL-STD-202, method 208 guaranteed Mounting position: Any Weight: 0.02ounce, 0.4gram





Dimensions in inches and (millimeters)

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Maximum Ratings and Electrical Characteristics

Ratings at 25 °C ambient temperature unless otherwise specified. Single phase, half wave, $60H_Z$, resistive or inductive load. For capacitive load, derate current by 20%.

	Symbols	DB201	DB202	DB203	DB204	DB205	DB206	DB207	Units
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward	Т	2.0							Amp
Rectified Current at T _A =40°C	I _(AV)								
Peak Forward Surge Current,									
8.3ms single half-sine-wave	I _{FSM} 60							Amp	
superimposed on rated load (JEDEC method)									
Maximum Forward Voltage	V _F	1.1							Volts
at 1.0A DC and 25 °C									
Maximum Reverse Current at T _A =25°C	T	5.0							uAmp
at Rated DC Blocking Voltage T _A =125°C	IR	500							
Typical Junction Capacitance (Note 1)	CJ	25							pF
Typical Thermal Resistance (Note 2)	R _{0JA}	40							°C/W
Typical Thermal Resistance (Note 2)	R _{0JL}	15							°C/W
Operating and Storage Temperature Range	T _J , Tstg				-55 to +15	0			Ċ

NOTES:

1- Measured at 1 MH_Z and applied reverse voltage of 4.0 VDC.

2- Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.5 x 0.5" (13 x 13mm) copper pads



RATINGS AND CHARACTERISTIC CURVES

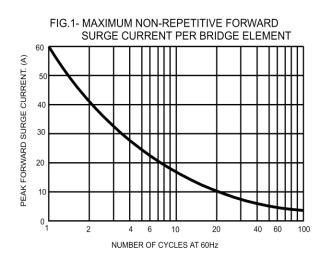
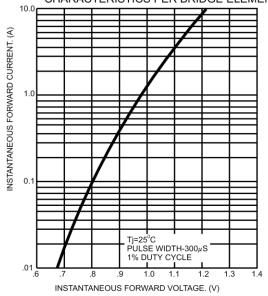


FIG.3- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS PER BRIDGE ELEMENT



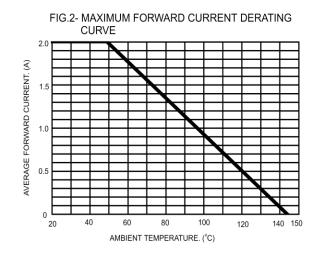
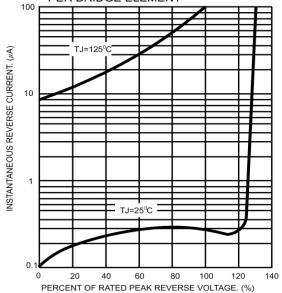


FIG.4- TYPICAL REVERSE CHARACTERISTICS PER BRIDGE ELEMENT



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DONGGUAN YOU FENG WEI ELECTRONICS CO., LTD

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